

04-04-2002

tty. Docket No. YOR920010775US1



SHEET

102044037

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1. Name of conveying party(ies):

Asit Dan
Gautam Kar
Alexander Keller
Heiko H. Ludwig

3.25.02

Additional name(s) of conveying
party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: International Business
Machines Corporation
Address: New Orchard Road
Armonk, NY 10504

Additional name(s) & addresses
attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

Execution Date(s): December 14, 2001;
December 14, 2001; December 17, 2001
and December 14, 2001 respectively.

4. Patent Application number(s)

Serial No. 10/017,814 Confirmation No. 5023

Execution Date(s): December 14, 2001;
December 14, 2001; December 17, 2001
and December 14, 2001 respectively.

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Robert M. Trepp
Address: IBM Corporation
Intellectual Property Law
P.O. Box 218
Yorktown Heights, NY 10598

6. Total number of applications involved: 1

7. Total fee (37 CFR 3.41): \$40.00

☒ Charge to Deposit Account No.:
09-0468

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Robert M. Trepp (Reg. No. 25,933)
Name of Person Signing

Signature

Date

Robert M. Trepp 3/18/2002

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Assignment

Whereas, we

Inventor
and City

(1)	Asit Dan	of Pleasantville
County of	Westchester	and State of New York
and (2)	Gautam Kar	of Yorktown Heights
County of	Westchester	and State of New York
and (3)	Alexander Keller	of Mamaroneck
County of	Westchester	and State of New York
and (4)	Heiko Hary Ludwig	of New York
County of	New York	and State of New York

have invented certain improvements in

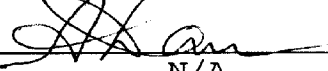
TITLE **ELECTRONIC CONTRACTS WITH PRIMARY AND SPONSORED ROLES**


and executed, respectively, a United States patent application therefor on


DATES THAT (1) 12/14 2001, and (2) 12/14/ 2001, and (3) 12/17/2001, and
INVENTORS (4) 12/14/2001.
SIGNED THE
DECLARATION

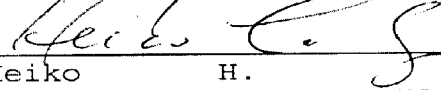
Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM) desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed
CITY (1) at Hawthorne, N.Y.  SIGNATURE
DATE on 12/14/01 2001, (Asit N/A Dan) INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (2) at Hawthorne, N.Y.  SIGNATURE
DATE on Dec. 14, 2001 2001, (Gautam N/A Kar) INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (3) at Hawthorne, N.Y.  SIGNATURE
DATE on 12/17/2001 2001, (Alexander N/A Keller) INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (4) at Hawthorne  SIGNATURE
DATE on Dec 14, 2001 2001, (Heiko H. Ludwig) INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME